

LGM40PI120C1T3A

1200V/40A PIM in one-package

FEATURES

- V_{CEsat} with positive temperature coefficient
- Low V_{CEsat}
- Low inductance case
- 10 μ s short circuit capability
- Isolated copper baseplate using DBC technology

Preliminary Data

$V_{CES} = 1200V$

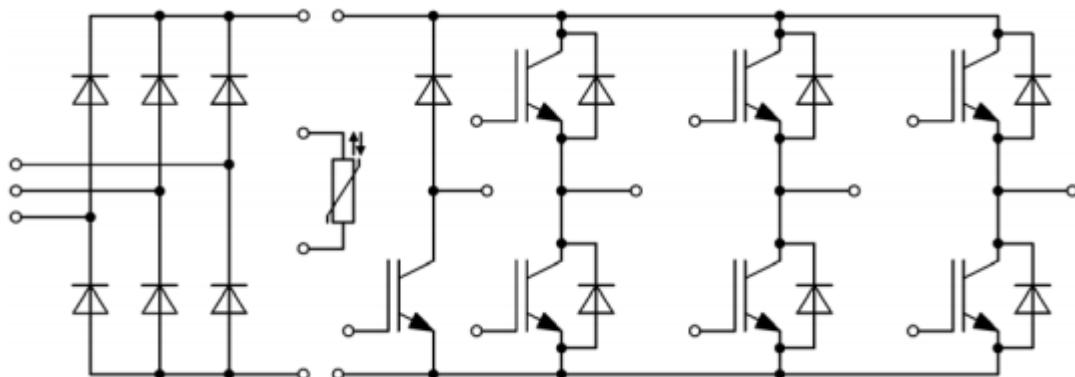
IC nom = 40A / ICRM = 80A



APPLICATION

- Motor drivers
- Air Conditioning
- Auxiliary inverters

Equivalent Circuit Schematic



**IGBT, Inverter
Maximum Rated Values**

Parameter	Conditions	Symbol	Values		Units
Collector-emitter voltage	Tvj = 25°C	V _{CES}	1200		V
Continuous DC collector current	T _C = 100°C, Tvj max = 175°C T _C = 25°C, Tvj max = 175°C	I _C	40 68		A
Repetitive peak collector current	t _P = 1 ms	I _{CRM}	80		A
Total power dissipation	T _C = 25°C, Tvj max = 175°C	P _{tot}	272		W
Gate-emitter peak voltage		V _{GE}	±20		V

Characteristic Values

Parameter	Conditions	Symbol	Values			Units
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	I _C = 40A, V _{GE} = 15 V Tvj = 25°C	V _{CESat}		1.85		V
Gate threshold voltage	I _C = 1.5 mA, V _{CE} = V _{GE} Tvj = 25°C	V _{GTh}		6.5		V
Gate charge	V _{GE} = -15 / 15 V	Q _G		0.167		μC
Input capacitance	f = 1 MHz, Tvj = 25°C, V _{CE} = 25 V, V _{GE} = 0 V	C _{ies}		3.53		nF
Reverse transfer capacitance		C _{res}		0.11		nF
Collector-emitter cut-off current	V _{CE} = 1200 V, V _{GE} = 0 V, Tvj = 25°C	I _{CES}			1.0	mA
Gate-emitter leakage current	V _{CE} = 0 V, V _{GE} = 20 V, Tvj = 25°C	I _{GES}			400	nA
Turn-on delay time, inductive load	I _C = 40 A, V _{CE} = 600 V V _{GE} = -15 / 15 V , RG = 10Ω Tvj = 25°C	t _{d on}		0.15		μs
Rise time, inductive load		t _r		0.09		μs
Turn-off delay time, inductive load		t _{d off}		0.11		μs
Fall time, inductive load		t _f		0.16		μs
Turn-on energy loss per pulse		E _{on}		3.2		mJ
Turn-off energy loss per pulse		E _{off}		4		mJ
SC data	V _{GE} ≤ 15 V, V _{CC} = 800 V t _P ≤ 10 μs, Tvj = 25°C	I _{SC}		254		A
Thermal resistance, junction to case	per IGBT	R _{thJC}			0.55	K/W
Thermal resistance, case to heatsink	per IGBT λ _{Paste} =1 W/(m·K) / λ _{grease} =1 W/(m·K)	R _{thCH}		0.27		K/W
Temperature under switching conditions		Tvj op	-40		150	°C

Diode, Inverter

Maximum Rated Values

Parameter	Conditions	Symbol	Values		Units
Repetitive peak reverse voltage	$T_{vj} = 25^\circ\text{C}$	V_{RRM}	1200		V
Continuous DC forward current		I_F	40		A
Repetitive peak forward current	$t_p = 1 \text{ ms}$	I_{FRM}	80		A

Characteristic Values

Parameter	Conditions	Symbol	Values			Units
			Min.	Typ.	Max.	
Forward voltage	$I_F = 40 \text{ A}, V_{GE} = 0 \text{ V}$ $T_{vj} = 25^\circ\text{C}$	V_F		2.00		V
Peak reverse recovery current		I_{RR}		43		A
Recovered charge	$I_F = 40 \text{ A}, -dI_F/dt = 1400 \text{ A}/\mu\text{s}$ $V_R = 600 \text{ V}, V_{GE} = -15 \text{ V}$ $T_{vj} = 25^\circ\text{C}$	Q_{RR}		1.9		μC
Reverse recovery energy		E_{rec}		0.8		mJ
Thermal resistance, junction to case	per diode	R_{thJC}			1..05	K/W
Thermal resistance, case to heatsink	per diode $I_{paste} = 1 \text{ W}/(\text{m}\cdot\text{K}) / I_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$	R_{thCH}		0.5		K/W
Temperature under switching conditions		$T_{vj op}$	-40		150	$^\circ\text{C}$

Diode, Rectifier

Maximum Rated Values

Parameter	Conditions	Symbol	Values		Units
Repetitive peak reverse voltage	$T_{vj} = 25^\circ\text{C}$	V_{RRM}	1600		V
Maximum RMS current at rectifier output	$T_c=80^\circ\text{C}$	I_F	40		A
Surge forward current	$t_p = 10 \text{ ms}, T_{vj} = 25^\circ\text{C}$	I_{FSM}	580		A
I^2t - value	$t_p = 10 \text{ ms}, T_{vj} = 25^\circ\text{C}$	I^2t	1950		A^2s

Characteristic Values

Parameter	Conditions	Symbol	Values			Units
			Min.	Typ.	Max.	
Forward voltage	$T_{vj} = 25^\circ\text{C}, I_F = 40 \text{ A}$	V_F		1.2		V
Reverse current	$T_{vj} = 25^\circ\text{C}, VR = 1600 \text{ V}$	I_R		1.00		mA
Thermal resistance, junction to case	per diode	R_{thJC}			0.87	K/W
Thermal resistance, case to heatsink	per diode $I_{paste} = 1 \text{ W}/(\text{m}\cdot\text{K}) / I_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$	R_{thCH}		0.46		K/W
Temperature under switching conditions		$T_{vj op}$	-40		150	$^\circ\text{C}$

**IGBT, Brake-Chopper
Maximum Rated Values**

Parameter	Conditions	Symbol	Values		Units
Collector-emitter voltage	Tvj = 25°C	V _{CES}	1200		V
Continuous DC collector current	T _C = 100°C, Tvj max = 175°C T _C = 25°C, Tvj max = 175°C	I _C	15 30		A
Repetitive peak collector current	t _P = 1 ms	I _{CRM}	30		A
Total power dissipation	T _C = 25°C, Tvj max = 175°C	P _{tot}	147		W
Gate-emitter peak voltage		V _{CES}	±20		V

Characteristic Values

Parameter	Conditions	Symbol	Values			Units
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	I _C = 15 A, V _{GE} = 15 V Tvj = 25°C	V _{CESat}		1.9		V
Gate threshold voltage	I _C = 0.48 mA, V _{CE} = V _{GE} Tvj = 25°C	V _{GTh}		5.9		V
Gate charge	V _{GE} = -15 / 15 V	Q _G		0.12		μC
Input capacitance	f = 1 MHz, Tvj = 25°C, V _{CE} = 25 V, V _{GE} = 0 V	C _{ies}		0.95		nF
Reverse transfer capacitance		C _{res}		0.04		nF
Collector-emitter cut-off current	V _{CE} = 1200 V, V _{GE} = 0 V, Tvj = 25°C	I _{CES}			1.0	mA
Gate-emitter leakage current	V _{CE} = 0 V, V _{GE} = 20 V, Tvj = 25°C	I _{GES}			400	nA
Turn-on delay time, inductive load	I _C = 15 A, V _{CE} = 600 V V _{GE} = -15 / 15 V , RG = 20Ω Tvj = 25°C	t _{d on}		0.035		μs
Rise time, inductive load		t _r		0.03		μs
Turn-off delay time, inductive load		t _{d off}		0.09		μs
Fall time, inductive load		t _f		0.13		μs
Turn-on energy loss per pulse		E _{on}		1.75		mJ
Turn-off energy loss per pulse		E _{off}		0.4		mJ
SC data	V _{GE} ≤ 15 V, V _{CC} = 800 V t _P ≤ 10 μs, Tvj = 25°C	I _{SC}		130		A
Thermal resistance, junction to case	per IGBT	R _{thJC}		1.02	1.15	K/W
Thermal resistance, case to heatsink	per IGBT λ _{Paste} =1 W/(m·K) / λ _{grease} =1 W/(m·K)	R _{thCH}		1.02		K/W
Temperature under switching conditions		Tvj op	-40		150	°C

**Diode, Brake-Chopper
Maximum Rated Values**

Parameter	Conditions	Symbol	Values		Units
Repetitive peak reverse voltage	$T_{vj} = 25^\circ\text{C}$	V _{RRM}	1200		V
Continuous DC forward current		I _F	15		A
Repetitive peak forward current	$t_p = 1 \text{ ms}$	I _{FRM}	30		A

Characteristic Values

Parameter	Conditions	Symbol	Values			Units
			Min.	Typ.	Max.	
Forward voltage	$I_F = 15 \text{ A}, V_{GE} = 0 \text{ V}$ $T_{vj} = 25^\circ\text{C}$	V _F		1.9		V
Peak reverse recovery current		I _{RR}		24		A
Recovered charge	$I_F = 15 \text{ A}, -dI_F/dt = 1200 \text{ A}/\mu\text{s}$ ($T_{vj}=150^\circ\text{C}$) $V_R = 600 \text{ V}, V_{GE} = -15 \text{ V}$ $T_{vj} = 25^\circ\text{C}$	Q _{RR}		1.8		μC
Reverse recovery energy		E _{rec}		0.35		mJ
Thermal resistance, junction to case	per diode	R _{thJC}		1.68	1.8	K/W
Thermal resistance, case to heatsink	per diode $I_{paste} = 1 \text{ W}/(\text{m}\cdot\text{K}) / I_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$	R _{thCH}		1.2		K/W
Temperature under switching conditions		T _{vj op}	-40		150	°C

**NTC-Thermistor
Characteristic Values**

Parameter	Conditions	Symbol	Values			Units
			Min.	Typ.	Max.	
Rated resistance	$T_{NTC} = 25^\circ\text{C}$	R ₂₅		5		kΩ
Deviation of R ₁₀₀	$T_{NTC} = 100^\circ\text{C}, R_{100} = 493 \Omega$	ΔR/R	-5		5	%
Power dissipation	$T_{NTC} = 25^\circ\text{C}$	P ₂₅			20	mW

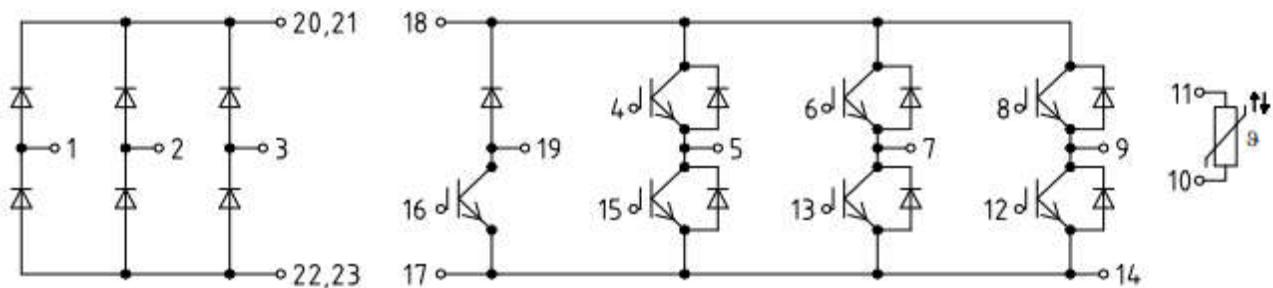
Module
Maximum Rated Values

Parameter	Conditions	Symbol	Values		Units
Isolation test voltage	RMS, f = 50 Hz, t = 1 min.	VISOL	2.5		kV
Internal isolation	basic insulation (class 1, IEC 61140)		Al ₂ O ₃		
Creepage distance	terminal to heatsink terminal to terminal		10		mm
Clearance	terminal to heatsink terminal to terminal		7.5		mm
Comparative tracking index		CTI	>200		

Characteristic Values

Parameter	Conditions	Symbol	Values			Units
			Min.	Typ.	Max.	
Stray inductance module and fixture		L _{sCE}		60		nH
Module lead resistance, terminals - chip	TC = 25°C, per switch	R _{CC' + EE'} R _{AA' + CC'}		4 3		mΩ
Storage temperature		T _{stg}	-40		125	°C
Mounting force per clamp		F	3		6	N
Weight		G		200		g

Circuit diagram



Package outlines (mm)

